IPC ASSOCIATION ELECTRONIC	Material Com © Copyright 2005. SINDUSTRIES international and P	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under b international and Pan-American copyright conventions.		nder both				ances within the manu lower level materials						
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				Materials and	ials and Mfg Information			
upplier	r Information													
Company name*			Company unique ID			τ	Unique ID Authority				Response Date*			
onsemi											2025-06-07			
ontact N	ame	Title - Contact			P	Phone - Contact*				Email - Contact*				
Product-F	Env-Stewards	Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com				
uthorize	d Representative*	Title - Representative			P	Phone - Representative*			Emai	Email - Representative*				
roduct-I	Env-Stewards	Product Enviro Compliance			I	NA				Product-Env-Stewards@onsemi.com				
	Requester Item Number		Mfr Item Number Mfr Item Name				Effective Date	Version	Manufacturing S	Manufacturing Site		UOM	Unit Type	
		FFH30S60STU ST2R TO2472L		ST2R TO2472L P	PN 30A 600V		2025-06-07		СРА	СРА		mg	Each	
lanufa	cturing Process Inform		Terminal Base	Allow	-STD-020 MS	I. Dotino	Dook Droop	as Dody Tame	May Time of	Pools Tompo	notives Number	on of Doflow Cv	olog	
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RoHS Material Composition Declaration			Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard										
RoHS Declaration * 4 - Item(s	) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.										
Supplier Digital Signature Ra	astislav Drska	-En								

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

<b>Homogeneous Material</b>	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	32.0	mg	Supplier	Silicon (Si)	7440-21-3		32	mg
Die Attach Solder	23.353	mg	Supplier	Silver (Ag)	7440-22-4		0.5838	mg
			A	Lead (Pb)	7439-92-1	7a	21.6015	mg
			Supplier	Tin (Sn)	7440-31-5		1.1677	mg
Lead Frame	3488.88	mg	Supplier	Zinc (Zn)	7440-66-6		1.74	mg
			В	Nickel (Ni)	7440-02-0		113.9998	mg
			Supplier	Iron (Fe)	7439-89-6		2.09	mg
			Supplier	Copper (Cu)	7440-50-8		3369.9998	mg
			Supplier	Phosphorus (P)	7723-14-0		1.05	mg
Mold Compound-Black	1739.8	mg	Supplier	Polymer(phenyl glycidil ether)-co- dicyclopentadiene	119345-05-0		86.99	mg
			Supplier	Proprietary	Proprietary Data		86.99	mg
			Supplier	Carbon Black (C)	1333-86-4		8.699	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		78.291	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		1304.8501	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		86.99	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		86.99	mg
Plating	31.0	mg	Supplier	Tin (Sn)	7440-31-5		31	mg
Wire Bond - Al	6.0	mg	Supplier	Aluminum (Al)	7429-90-5		6	mg